LM2682 Switched Capacitor Voltage Doubling Inverter

Check for Samples: LM2682

FEATURES

- **Inverts Then Doubles Input Supply Voltage**
- **Small VSSOP Package and SOIC Package**
- **90Ω Typical Output Impedance**
- **94% Typical Power Efficiency at 10 mA**

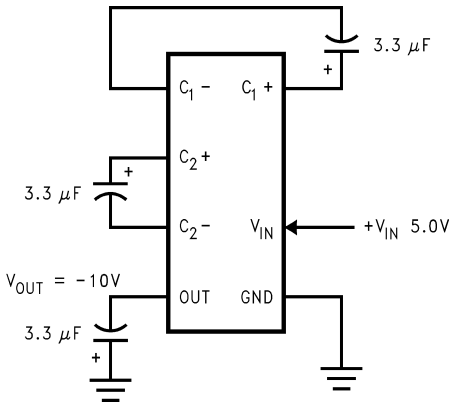
APPLICATIONS

- **LCD Contrast Biasing**
- **GaAs Power Amplifier Biasing**
- **Interface Power Supplies**
- **Handheld Instrumentation**
- **Laptop Computers and PDAs**

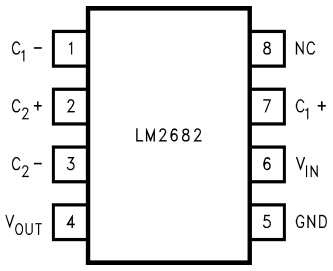
DESCRIPTION

The LM2682 is a CMOS charge-pump voltage inverter capable of converting positive voltage in the range of +2.0V to +5.5V to the corresponding doubled negative voltage of −4.0V to −11.0V respectively. The LM2682 uses three low cost capacitors to provide 10 mA of output current without the cost, size, and EMI related to inductor based circuits. With an operating current of only 150 µA and an operating efficiency greater than 90% with most loads, the LM2682 provides ideal performance for battery powered systems. The LM2682 offers a switching frequency of 6 kHz.

Typical Operating Circuit and Pin Configuration



8-Pin VSSOP or 8-Pin SOIC



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

All trademarks are the property of their respective owners.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of the Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

Copyright © 1999–2013, Texas Instruments Incorporated

Downloaded from Arrow.com.

Absolute Maximum Ratings(1)

Input Voltage (V_{IN})		+5.8V
V_{IN} dV/dT		1V/µsec
V_{OUT}		−11.6V
V_{OUT} Short-Circuit Duration		Continuous
Storage Temperature		−65°C to +150°C
Lead Temperature Soldering		+300°C
Power Dissipation(2)	VSSOP	300 mW
	SOIC	470 mW
T_{JMAX}		+150°C

(1) Absolute Maximum Ratings are those values beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but do not ensure specific performance limits. For ensured specifications and test conditions, see the Electrical Characteristics.

(2) The maximum power dissipation must be de-rated at elevated temperatures (only needed for T_A>85°C) and is limited by T_{JMAX} (maximum junction temperature), θ_{J-A} (junction to ambient thermal resistance) and T_A (ambient temperature). θ_{J-A} is 140°C/W for the SOIC-8 package and 220°C/W for the VSSOP-8 package. The maximum power dissipation at any temperature is:$PDiss_{MAX} = (T_{JMAX} - T_A)/\theta_{J-A}$ up to the value listed in the Absolute Maximum Ratings.

Operating Ratings

ESD Susceptibility(1)	Human Body Model	2 kV
	Machine Model	200V
Ambient Temp. Range		−40°C to +85°C
Junction Temp. Range		−40°C to +125°C

(1) The human body model is a 100 pF capacitor discharged through a 1.5 kΩ resistor into each pin. The machine model is a 200pF capacitor discharged directly into each pin.

LM2682 Electrical Characteristics

V_{IN} = 5V and $C_1 = C_2 = C_3$ = 3.3µF unless otherwise specified. Limits with **bold typeface** apply over the full operating ambient temperature range, −40°C to +85°C, limits with standard typeface apply for T_A = 25°C.

Symbol	Parameter	Conditions	Min	Typical(1)	Max	Units
V_{IN}	Supply Voltage Range	R_L = 2 kΩ	**2.0**		**5.5**	V
I_{IN}	Supply Current	Open Circuit, No Load		150	300 **400**	µA
R_{OUT}	V_{OUT} Source Resistance	I_L = 10 mA		90	150 **200**	Ω
		I_L=5 mA, V_{IN}=2 V		110	**250**	Ω
f_{OSC}	Oscillator Frequency	See(2)		12	**30**	kHz
f_{SW}	Switching Frequency	See(2)		6	**15**	kHz
η_{POWER}	Power Efficiency	R_L = 2k(3)	90	93		%
$\eta_{VOLTAGE}$	Voltage Conversion Efficiency			99.9		%

(1) Typical numbers are at 25°C and represent the most likely norm.
(2) The output switches operate at one half of the oscillator frequency, $f_{OSC} = 2f_{SW}$.
(3) The minimum specification is specified by design and is not tested.

Copyright © 1999–2013, Texas Instruments Incorporated

Downloaded from Arrow.com.

Table 1. PIN DESCRIPTIONS

Pin Number	Symbol	Description
1	C_1-	Capacitor C_1 negative terminal
2	C_2+	Capacitor C_2 positive terminal
3	C_2-	Capacitor C_2 negative terminal
4	V_{OUT}	Negative output voltage ($-2V_{IN}$)
5	GND	Device ground
6	V_{IN}	Power supply voltage
7	C_1+	Capacitor C_1 positive terminal
8	NC	No Connection

Copyright © 1999–2013, Texas Instruments Incorporated

Downloaded from Arrow.com.

Typical Performance Characteristics

V_{IN} = 5V and T_A = 25°C unless otherwise noted.

Output Resistance vs Input Voltage

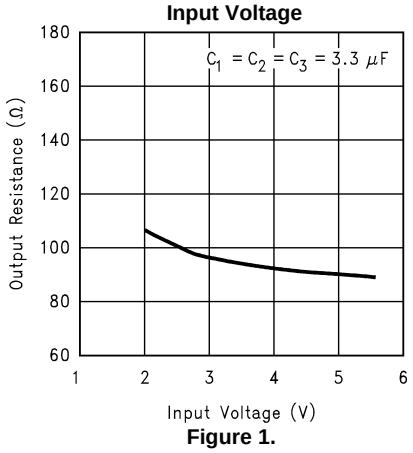


Figure 1.

Output Voltage vs Load Current

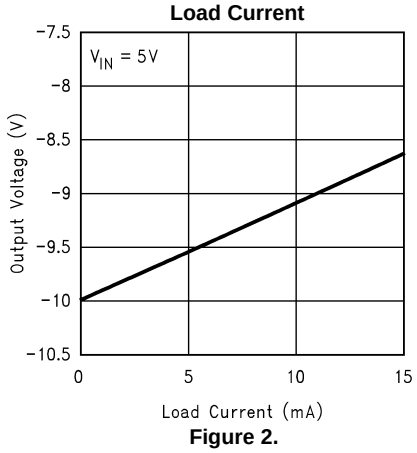


Figure 2.

Supply Current vs Input Voltage

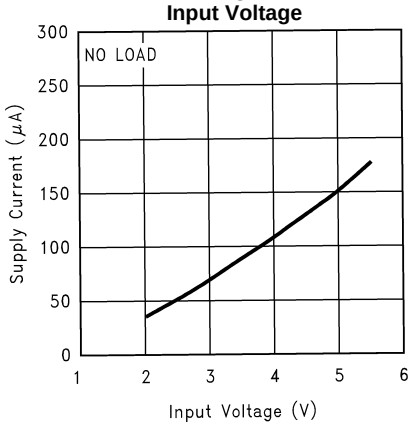


Figure 3.

Output Resistance vs Temperature

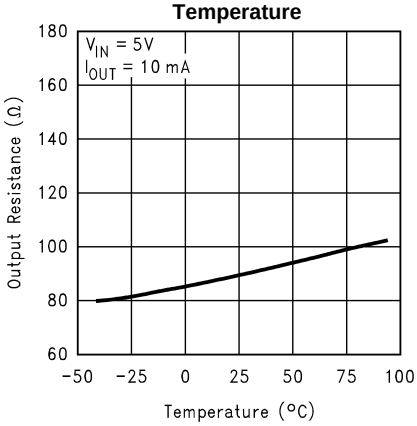


Figure 4.

Output Voltage Ripple vs Load Current

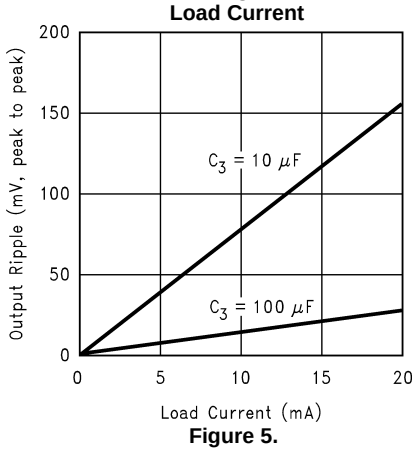


Figure 5.

Copyright © 1999–2013, Texas Instruments Incorporated

Downloaded from Arrow.com.

BASIC APPLICATION CIRCUITS

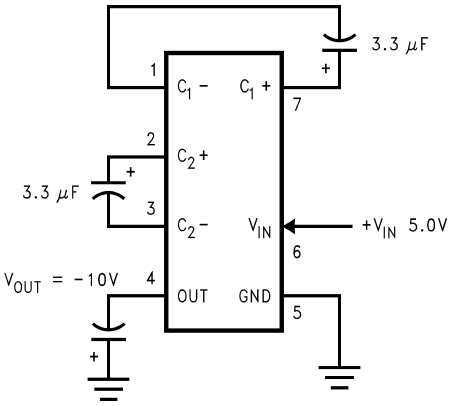


Figure 6. Doubling Voltage Inverter

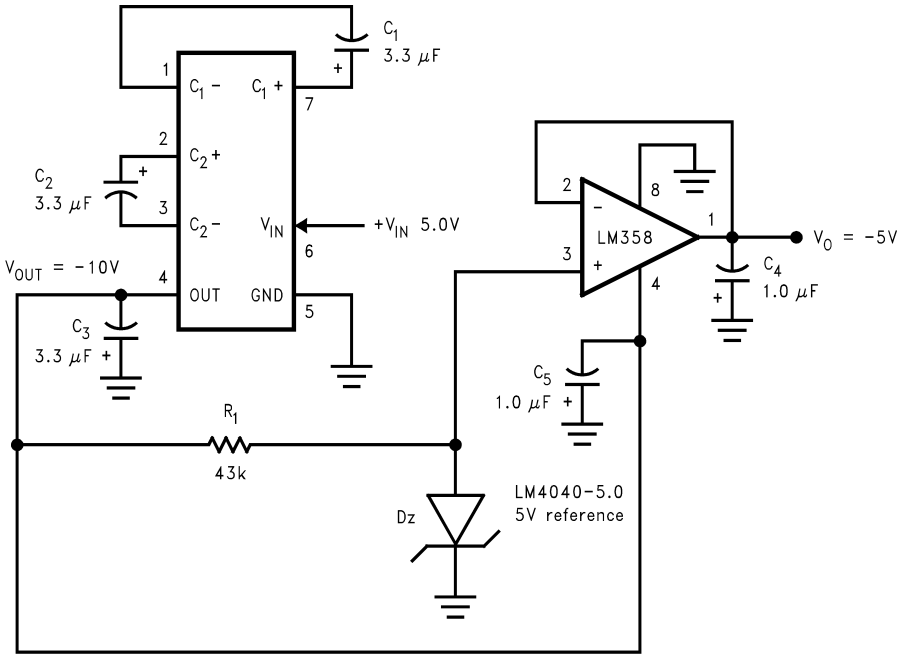


Figure 7. +5V to −5V Regulated Voltage Converter

Downloaded from Arrow.com.

APPLICATION INFORMATION

VOLTAGE DOUBLING INVERTER

The main application of the LM2682 is to generate a negative voltage that is twice the positive input voltage. This circuit requires only three external capacitors and is connected as shown in Figure 6. It is important to keep in mind that the efficiency of the circuit is determined by the output resistance. A derivation of the output resistance is shown below:

$$R_{OUT} = 2(R_{SW1}+R_{SW2}+ESR_{C1}+R_{SW3}+R_{SW4}+ESR_{C2}) +2(R_{SW1}+R_{SW2}+ESR_{C1}+R_{SW3}+R_{SW4}+ESR_{C2}) + 1/(f_{OSC}\times C1) + 1/(f_{OSC}\times C2) + ESR_{C3}$$

Using the assumption that all four switches have the same ON resistance our equation becomes:

$$R_{OUT} = 16R_{SW} + 4ESR_{C1} + 4ESR_{C2} + ESR_{C3} + 1/(f_{OSC}\times C1) + 1/(f_{OSC}\times C2)$$

Output resistance is typically 90Ω with an input voltage of +5V, an operating temperature of 25°C, and using low ESR 3.3 µF capacitors. This equation shows the importance of capacitor selection. Large value, low ESR capacitors will reduce the output resistance significantly but will also require a larger overall circuit. Smaller capacitors will take up less space but can lower efficiency greatly if the ESR is large. Also to be considered is that C1 must be rated at 6 VDC or greater while C2 and C3 must be rated at 12 VDC or greater.

The amount of output voltage ripple is determined by the output capacitor C3 and the output current as shown in this equation:

$$V_{RIPPLE\ P\text{-}P} = I_{OUT} \times (2\times ESR_{C3} + 1/[2\times(f_{OSC}\times C3)])$$

Once again a larger capacitor with smaller ESR will give better results.

+5V TO −5V REGULATED VOLTAGE CONVERTER

Another application in which the LM2682 can be used is for generating a −5V regulated supply from a +5V unregulated supply. This involves using an op-amp and a reference and is connected as shown in Figure 7. The LM358 op-amp was chosen for its low cost and versatility and the LM4040-5.0 reference was chosen for its low bias current requirement. Of course other combinations may be used at the designer's discretion to fit accuracy, efficiency, and cost requirements. With this configuration the circuit is well regulated and is still capable of providing nearly 10 mA of output current. With a 9 mA load the circuit can typically maintain 5% regulation on the output voltage with the input varying anywhere from 4.5V to the maximum of 5.5V. With less load the results are even better. Voltage ripple concerns are reduced in this case since the ripple at the output of the LM2682 is reduced at the output by the PSRR of the op-amp used.

Copyright © 1999–2013, Texas Instruments Incorporated

Downloaded from Arrow.com.

PARALLELING DEVICES

Any number of devices can be paralleled to reduce the output resistance. As shown in Figure 8, each device must have its own pumping capacitors, C1 and C2, but only one shared output capacitor is required. The effective output resistance is the output resistance of one device divided by the number of devices used in parallel. Paralleling devices also gives the capability of increasing the maximum output current. The maximum output current now becomes the maximum output current for one device multiplied by the number of devices used in parallel. For example, if you parallel two devices you can get 20 mA of output current and have half the output resistance of one device supplying 10 mA.

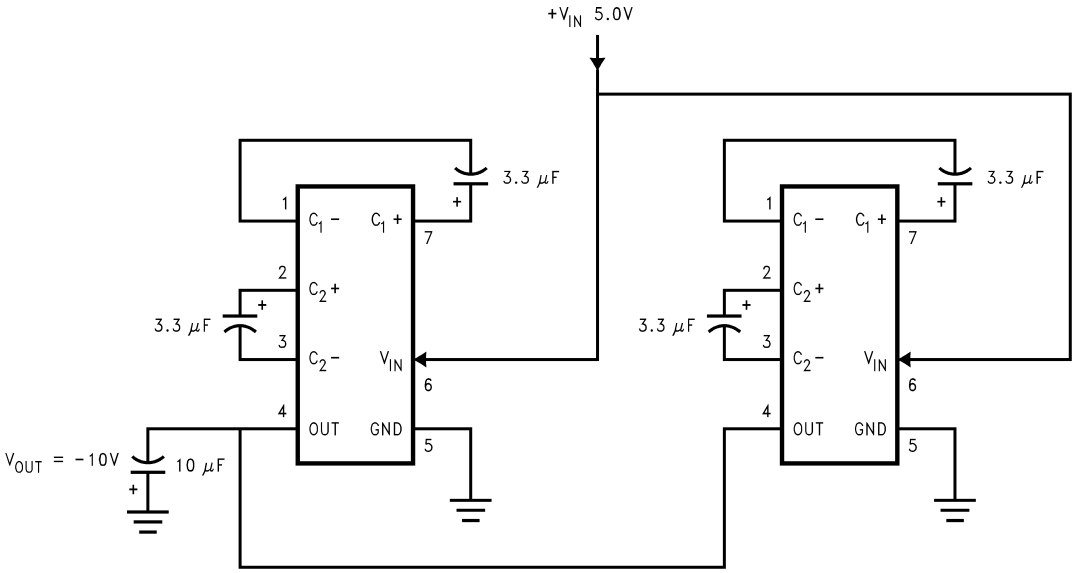


Figure 8. Paralleling Devices

Downloaded from Arrow.com.

REVISION HISTORY

Changes from Revision A (May 2013) to Revision B	Page
• Changed layout of National Data Sheet to TI format	7

Copyright © 1999–2013, Texas Instruments Incorporated

Downloaded from Arrow.com.

PACKAGE OPTION ADDENDUM

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
LM2682MM/NOPB	ACTIVE	VSSOP	DGK	8	1000	RoHS & Green	SN	Level-1-260C-UNLIM	-40 to 85	S11A	Samples
LM2682MMX/NOPB	ACTIVE	VSSOP	DGK	8	3500	RoHS & Green	SN	Level-1-260C-UNLIM	-40 to 85	S11A	Samples

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

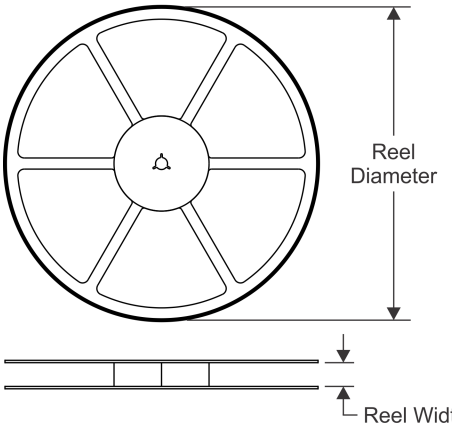
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

Downloaded from Arrow.com.

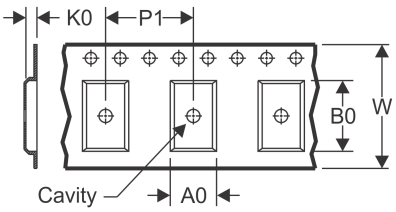
Downloaded from Arrow.com.

TAPE AND REEL INFORMATION

REEL DIMENSIONS

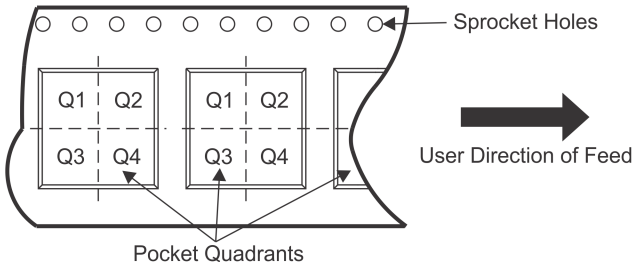


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

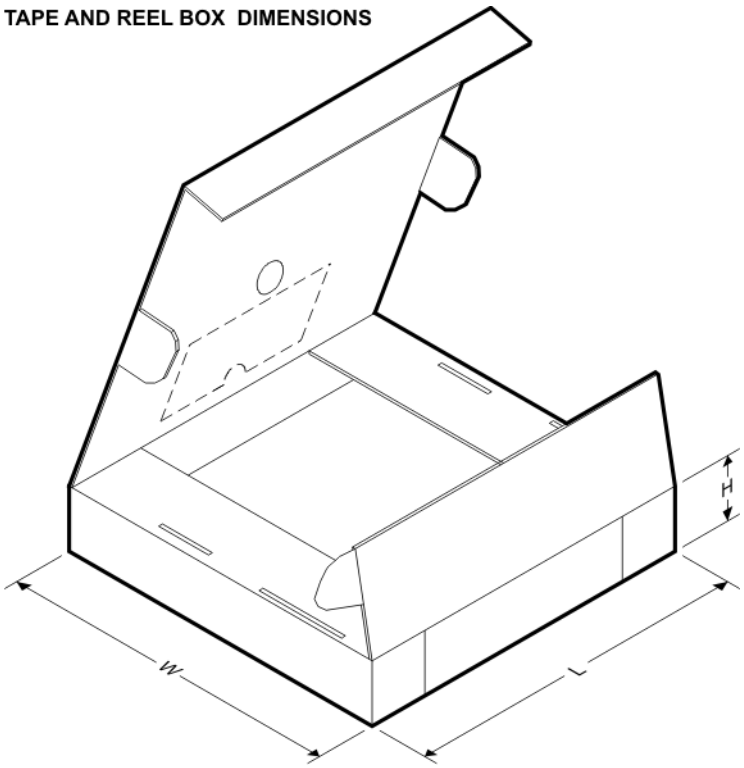


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM2682MM/NOPB	VSSOP	DGK	8	1000	178.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LM2682MMX/NOPB	VSSOP	DGK	8	3500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1

Downloaded from Arrow.com.

TAPE AND REEL BOX DIMENSIONS

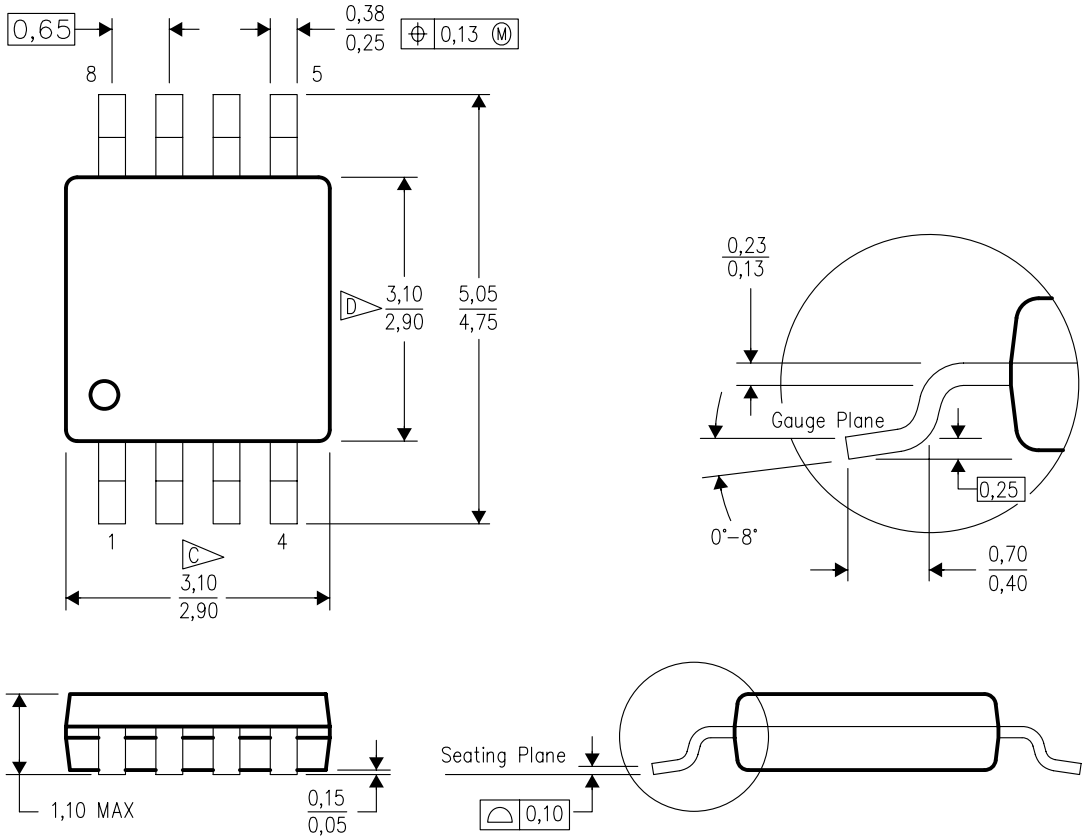


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM2682MM/NOPB	VSSOP	DGK	8	1000	210.0	185.0	35.0
LM2682MMX/NOPB	VSSOP	DGK	8	3500	367.0	367.0	35.0

Downloaded from Arrow.com.

DGK (S–PDSO–G8) PLASTIC SMALL–OUTLINE PACKAGE

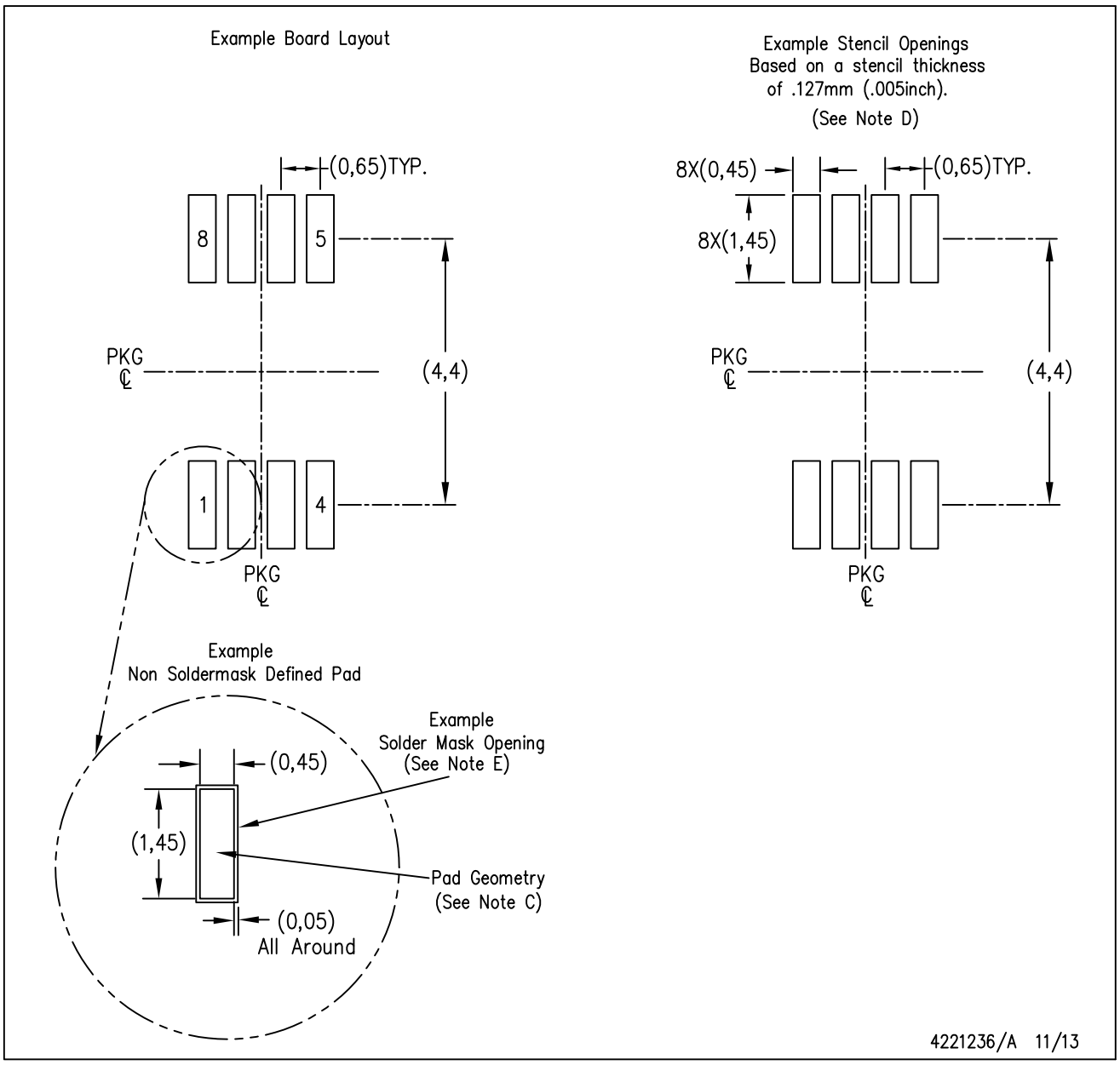


4073329/E 05/06

NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 per end.
D. Body width does not include interlead flash. Interlead flash shall not exceed 0.50 per side.
E. Falls within JEDEC MO–187 variation AA, except interlead flash.

Downloaded from Arrow.com.

DGK (S–PDSO–G8) PLASTIC SMALL OUTLINE PACKAGE



NOTES:
A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Publication IPC–7351 is recommended for alternate designs.
D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC–7525 for other stencil recommendations.
E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

Downloaded from Arrow.com.

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES “AS IS” AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI’s products are provided subject to TI’s Terms of Sale (www.ti.com/legal/termsofsale.html) or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI’s provision of these resources does not expand or otherwise alter TI’s applicable warranties or warranty disclaimers for TI products.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2020, Texas Instruments Incorporated

Downloaded from Arrow.com.